



Product Summary

BV _{DSS}	Rds(on) (max)	Package	I _{D (MAX)} T _A = +25°C
30V	190mΩ @ V _{GS} = 10V	SOT363	1A
300	$335m\Omega @ V_{GS} = 4.5V$	301303	0.75A

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- **Power Management Functions**
- Load Switch

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- **ESD** Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.006 grams (Approximate)

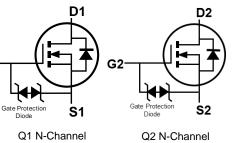


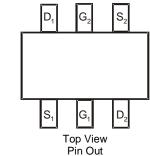


SOT363

Top View

3





Ordering Information (Note 4)

	Part Number	Case	Packaging			
	DMN3190LDW-7	SOT363	3000/Tape & Reel			
DMN3190LDW-13		SOT363	10000/Tape & Reel			
Notes:	lotes: 1. No purposely added lead, Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

G1

Marking Information

			N3′ WA	G, S 1 YM I EN G ₂ [YM = Dai Y = Year	te Code M (ex: G = 2					
Date Code Key												
Year	201	1	~		2019	20	20	2021		2022		2023
Code	Y		~		G		Η			J		Κ
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	D

5

Code

6

8

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0

Ν

Dec

D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6) \/as - 10\/	Steady State	T _A = +25°C T _A = +70°C	ID	1000 900	mA
Continuous Drain Current (Note 6) V _{GS} = 10V	t < 5s	T _A = +25°C T _A = +70°C	ID	1300 1000	mA
Maximum Continuous Body Diode Forward Curren	t (Note 5)	Is	0.5	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	9.6	А		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	0.32	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	395	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	0.4	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State		R _{0JA}	320	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	143	0/11	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	- ,		- 71-			
Drain-Source Breakdown Voltage	BV _{DSS}	30	_		V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current @T _C = +25°C	IDSS		_	1	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}			±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.5		2.8	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	D		122	190	mΩ	$V_{GS} = 10V, I_D = 1.3A$
	R _{DS(ON)}		181	335	11152	$V_{GS} = 4.5V, I_D = 290mA$
Diode Forward Voltage	V _{SD}			1.2	V	$V_{GS} = 0V, I_{S} = 250mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		87	—	pF	
Output Capacitance		_	17	—	pF	V _{DS} = 20V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss		12	—	pF	1 = 1.00012
Gate Resistance	Rg		69.8	—	Ω	$f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$
Total Gate Charge (V _{GS} = 4.5V)	Qg		0.9	—	nC	
Total Gate Charge (V _{GS} = 10V)	Qg		2.0	—	nC)/ 10)/ I= 250mA
Gate-Source Charge			0.3	—	nC	$V_{DS} = 10V, I_D = 250mA$
Gate-Drain Charge	Q _{gs} Q _{gd}	-	0.3	—	nC	
Turn-On Delay Time	t _{D(ON)}		4.5	_	ns	
Turn-On Rise Time		_	8.9	—	ns	$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time		-	30.3	—	ns	$R_{G} = 10\Omega, I_{D} = 100mA$
Turn-Off Fall Time	t⊨	_	15.6	_	ns	

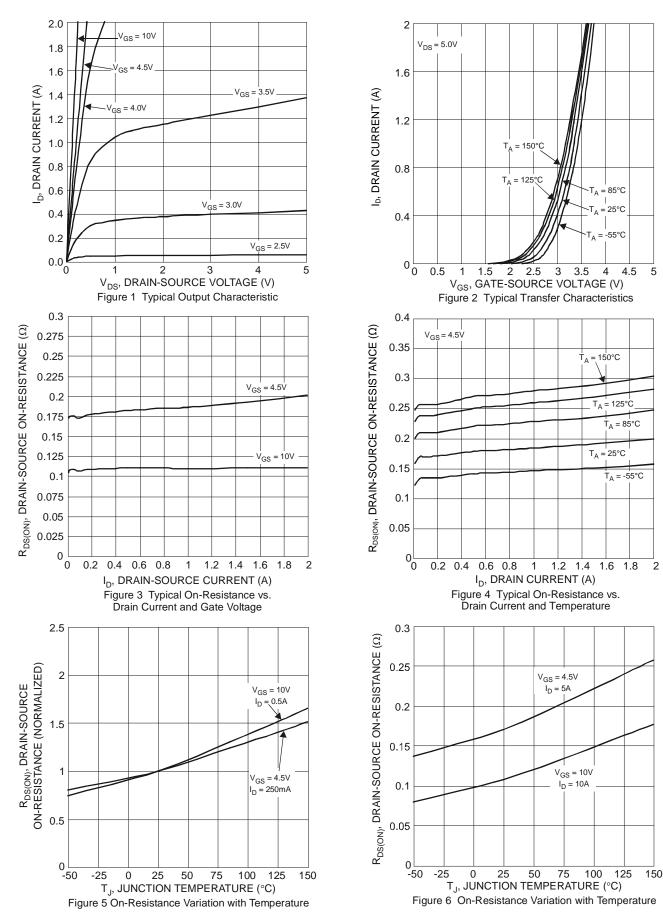
Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

6. Device mounted on $1" \times 1"$ FR-4 PCB with high coverage 2oz. Copper, single sided.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

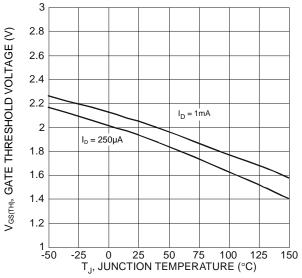


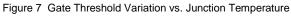


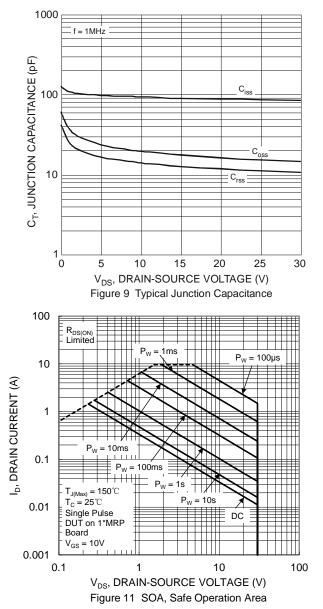
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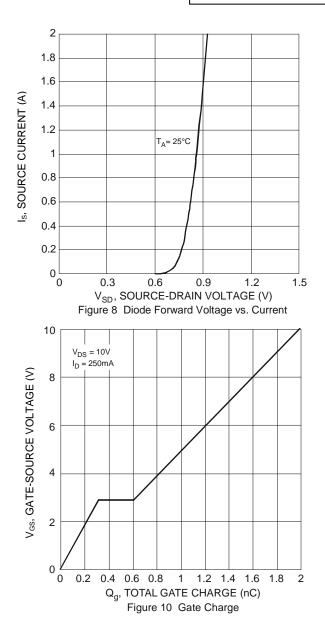


DMN3190LDW







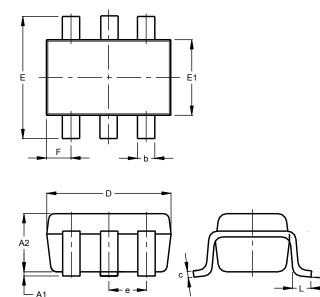




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363

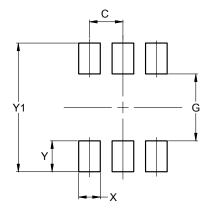


SOT363								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
E	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C).650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500



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